

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant	: Tomofumi MAEKAWA	Confirmation No.: 9960
Serial No	Group Art Unit: 1796 : 10/582,556 (National Stage of PCT/JP2004/018388)	
I.A. Filed	: December 9, 2004	Examiner: David Buttner
For	: THERMOPLASTIC RESIN HAVING RIGIDITY WHEN HEATED	

COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

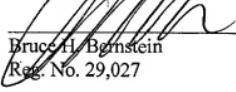
Commissioner of Patents
U.S. Patent and Trademark Office
Customer Window, Mail Stop Issue Fee
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In response to the Notice of Allowability, mailed by the U.S. Patent and Trademark Office on October 14, 2009, and to the Statement of Reasons for Allowance attached thereto, Applicants wish to clarify the record with respect to the basis for the patentability of claims in the present application. In this regard, while Applicants do not disagree with the Examiner's indication of allowability, Applicants submit that each of the claims in the present application recites a combination of features, and that the basis for patentability of each of these claims is based on the combination of features recited therein.

Should there be any questions, the Examiner is invited to contact the undersigned at the below- listed telephone number.

Respectfully submitted,
Tomofumi MAEKAWA


Bruce H. Bernstein
Reg. No. 29,027

January 13, 2010
GREENBLUM & BERNSTEIN, P.L.C.
1950 Roland Clarke Place
Reston, VA 20191
(703) 716-1191

Arnold Turk
Reg. No. 33094